



Final Product Change Notification

202204006F01 : Introduction of HTRC110 in Dark Green SO14 Package

Note: This notice is NXP Company Proprietary.

Issue Date: Apr 14, 2022 **Effective date:** Jul 13, 2022

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Management summary

Introduction of HTRC110 in Dark Green SO14 package

Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Process	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input checked="" type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Equipment	<input type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Location	<input type="checkbox"/> Electrical spec./Test coverage
<input type="checkbox"/> Firmware	<input type="checkbox"/> Other			

PCN Overview

Description

Introduction of HTRC110 in Dark Green SO14 package

Reason

The purpose of the release of HTRC110 in a new sub-package is to improve the ecological footprint of the NXP products, in line with the NXP environmental program, by converting all products to a halogen and antimony free RoHS compliant package.

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment Jul 13, 2022

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Additional information

Self qualification: [view online](#)

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by May 14, 2022.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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Changed Orderable Part#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	Product Line	Notes
HTRC11001T/02EE,11	935260091112	HTRC11001T/02EE	HITAG	SO14	SOT108-1	RFS	No	BLT1	
HTRC11001T/03EE,11	935260092118	HTRC11001T/03EE	HITAG	SO14	SOT108-1	RFS	No	BLT1	